



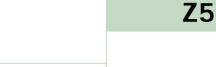
Specification

Description

The Z-Power series is designed for high current operation and high flux output applications.

It incorporates state of the art SMD design and low thermal resistant material.

The Z Power LED is ideal light sources for general illumination applications, custom designed solutions, automotive, large LCD backlights and high performance torches.



Features

- Super high Flux output and high Luminance
- Designed for high current operation
- SMT solderable
- Lead Free product
- RoHS compliant

Applications

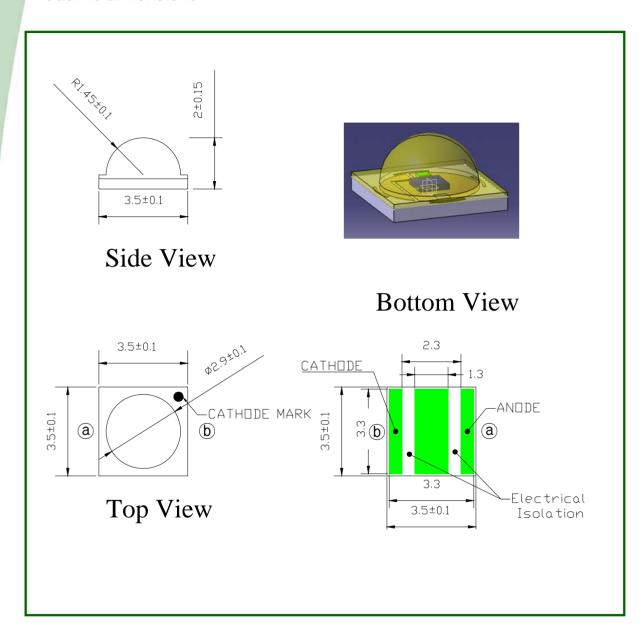
- Mobile phone flash
- Automotive interior / exterior lighting
- Automotive signal lighting
- Automotive forward lighting
- General Torch
- Architectural lighting
- LCD TV / Monitor Backlight
- Projector light source
- Traffic signals
- Task lighting
- Decorative / Pathway lighting
- Remote / Solar powered lighting

^{*} The appearance and specifications of the product can be changed for improvement without notice.





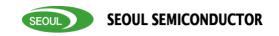
Outline dimensions



Notes:

- [1] All dimensions are in millimeters.
- [2] Scale: none
- [3] Undefined tolerance is ± 0.1 mm





Characteristics of Z5(Part no: SZW05A0A)

1. Pure white

1-1 Electro-Optical characteristics at 350mA

Parameter	Symbol	Value			l les it
Parameter		Min	Тур	Max	Unit
Luminous Flux ^[1]	Φ _V ^[2]		105		lm
Correlated Color Temperature [3]	ССТ	-	6300	-	К
CRI	R_a		70	-	-
Forward Voltage ^[4]	V _F		3.3	4	V
Thermal resistance (J to S)	$R\theta_{J-S}$		9		K/W
View Angle	2⊝ ½		120		deg.

1-2 Absolute Maximum Ratings

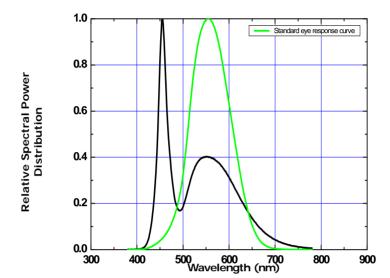
Parameter	Symbol	Value	Unit
Forward Current	l _F	700	mA
Reverse Voltage	V	5	V
Power Dissipation	P_{d}	2.8	W
Junction Temperature	T _j	145(@ I _F ≤ 700mA)	°C
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
ESD Sensitivity [5]	-	±8,000V HBM	-

*Notes:

- [1] SSC maintains a tolerance of $\pm 10\%$ on flux and power measurements.
- [2] Φ_V is the total luminous flux output as measured with an integrating sphere.
- [3] Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. Color coordinate : \pm 0.005, CCT \pm 5% tolerance.
- [4] Tolerance is ±0.06V on forward voltage measurements
- [5] A zener diode is included to protect the product from ESD.



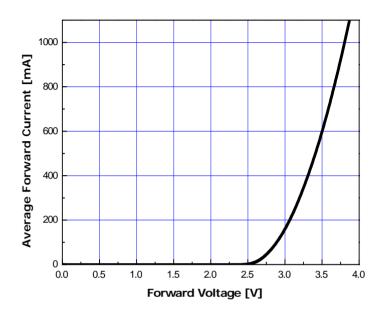
Color Spectrum T_A=25 ℃



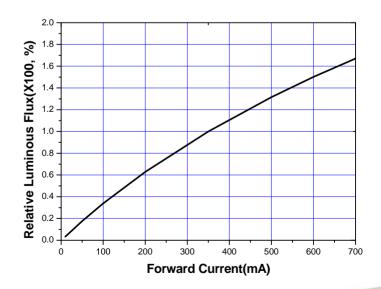


Forward Current Characteristics

Forward Voltage vs. Forward Current, Ta=25℃



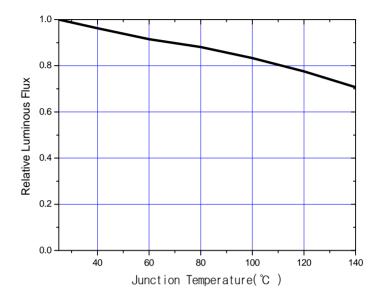
Forward Current vs. Normalized Relative Luminous Flux, Ta=25℃



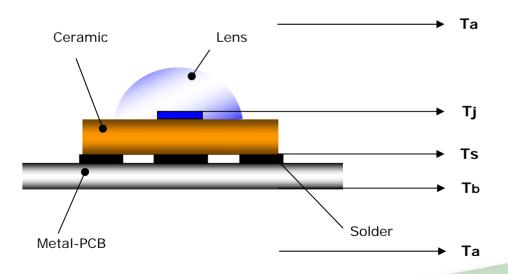


Junction Temperature Characteristics

Relative Light Output vs. Junction Temperature at IF=350mA, Ta=25℃



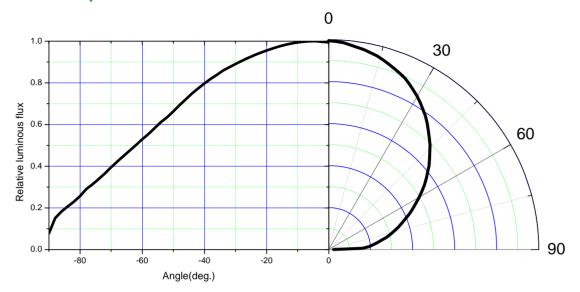
Temperature Characteristics Points



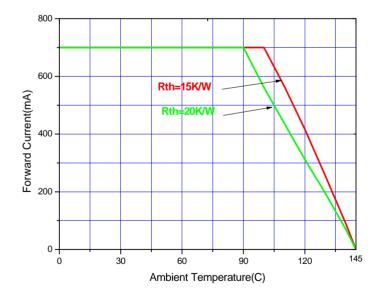




Radiation pattern



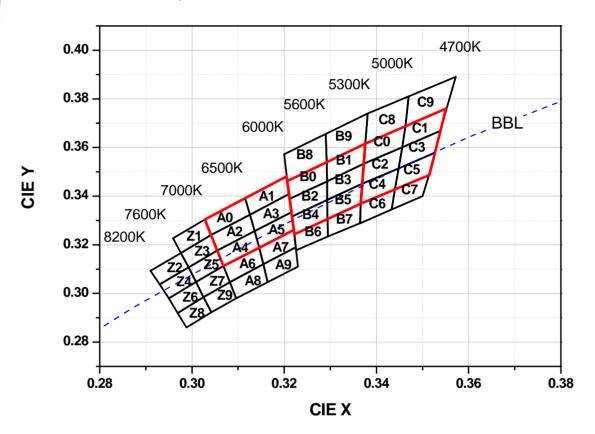
Maximum Forward Current vs. Ambient Temperature





Binning Structure

IF=350mA, Ta=25 ℃



* Note

Red area is ANSI chromaticity.



Color & Binning

COLOR RANK

<IF=350mA, Ta=25 $^{\circ}$ C>

	CIE X	CIE Y		CIE X	CIE Y
	0.2969	0.2919		0.3025	0.2985
	0.2988	0.2860		0.3042	0.2922
Z8	0.3042	0.2922	Z9	0.3096	0.2980
	0.3025	0.2985		0.3082	0.3046
	0.2969	0.2919		0.3025	0.2985
	0.2950	0.2980		0.3009	0.3047
	0.2969	0.2919		0.3025	0.2985
Z6	0.3025	0.2985	Z7	0.3082	0.3046
	0.3009	0.3047		0.3068	0.3113
	0.2950	0.2980		0.3009	0.3047
	0.2930	0.3037		0.2993	0.3107
	0.2950	0.2980		0.3009	0.3047
Z4	0.3009	0.3047	Z5	0.3068	0.3113
	0.2993	0.3107		0.3055	0.3177
	0.2930	0.3037		0.2993	0.3107
	0.2910	0.3093		0.2976	0.3166
	0.2930	0.3037		0.2993	0.3107
Z2	0.2993	0.3107	Z3	0.3055	0.3177
	0.2976	0.3166		0.3041	0.3240
	0.2910	0.3093		0.2976	0.3166
·			0.2959	0.3227	
				0.2976	0.3166
			Z1	0.3041	0.3240
				0.3028	0.3304
				0.2959	0.3227

 * Measurement Uncertainty of the Color Coordinates : $\pm~0.01$





COLOR RANK

<IF=350mA, Ta=25 $^{\circ}$ C>

	CIE X	CIE Y		CIE X	CIE Y
	0.3082	0.3046		0.3155	0.3120
	0.3096	0.2980		0.3164	0.3046
A8	0.3164	0.3046	A9	0.3230	0.3110
	0.3155	0.3120		0.3225	0.3190
	0.3082	0.3046		0.3155	0.3120
	0.3068	0.3113		0.3146	0.3187
	0.3082	0.3046		0.3155	0.3120
A6	0.3155	0.3120	A7	0.3225	0.3190
	0.3146	0.3187		0.3221	0.3261
	0.3068	0.3113		0.3146	0.3187
	0.3055	0.3177		0.3136	0.3256
	0.3068	0.3113	A 5	0.3146	0.3187
A4	0.3146	0.3187		0.3221	0.3261
	0.3136	0.3256		0.3216	0.3334
	0.3055	0.3177		0.3136	0.3256
	0.3041	0.3240		0.3126	0.3324
	0.3055	0.3177		0.3136	0.3256
A2	0.3136	0.3256	A3	0.3216	0.3334
	0.3126	0.3324		0.3210	0.3408
	0.3041	0.3240		0.3126	0.3324
	0.3028	0.3304		0.3115	0.3393
	0.3041	0.3240		0.3126	0.3324
A0	0.3126	0.3324	A1	0.3210	0.3408
	0.3115	0.3393		0.3205	0.3481
	0.3028	0.3304		0.3115	0.3393





COLOR RANK

<IF=350mA, Ta=25℃>

	CIE X	CIE Y		CIE X	CIE Y
	0.3222	0.3243		0.3294	0.3306
	0.3226	0.3178		0.3295	0.3234
В6	0.3295	0.3234	В7	0.3364	0.3288
	0.3294	0.3306		0.3366	0.3369
	0.3222	0.3243		0.3294	0.3306
	0.3217	0.3316		0.3293	0.3384
	0.3222	0.3243		0.3294	0.3306
B4	0.3294	0.3306	B5	0.3366	0.3369
	0.3293	0.3384		0.3369	0.3451
	0.3217	0.3316		0.3293	0.3384
	0.3212	0.3389		0.3293	0.3461
	0.3217	0.3316		0.3293	0.3384
B2	0.3293	0.3384	В3	0.3369	0.3451
	0.3293	0.3461		0.3373	0.3534
	0.3212	0.3389		0.3293	0.3461
	0.3207	0.3462		0.3292	0.3539
	0.3212	0.3389		0.3293	0.3461
В0	0.3293	0.3461	B1	0.3373	0.3534
	0.3292	0.3539		0.3376	0.3616
	0.3207	0.3462		0.3292	0.3539
	0.3200	0.3572		0.3290	0.3656
	0.3207	0.3462		0.3292	0.3539
B8	0.3292	0.3539	В9	0.3376	0.3616
	0.3290	0.3656		0.3381	0.3740
	0.3200	0.3572		0.3290	0.3656





COLOR RANK

<IF=350mA, Ta=25℃>

	CIE X	CIE Y		CIE X	CIE Y
	0.3366	0.3369		0.3440	0.3428
	0.3364	0.3288		0.3433	0.3345
C6	0.3433	0.3345	C7	0.3500	0.3400
	0.3440	0.3428		0.3514	0.3487
	0.3366	0.3369		0.3440	0.3428
	0.3369	0.3451		0.3448	0.3514
	0.3366	0.3369		0.3440	0.3428
C4	0.3440	0.3428	C5	0.3514	0.3487
	0.3448	0.3514		0.3526	0.3578
	0.3369	0.3451		0.3448	0.3514
	0.3373	0.3534		0.3456	0.3601
	0.3369	0.3451	C3	0.3448	0.3514
C2	0.3448	0.3514		0.3526	0.3578
	0.3456	0.3601		0.3539	0.3669
	0.3373	0.3534		0.3456	0.3601
	0.3376	0.3616		0.3463	0.3687
	0.3373	0.3534		0.3456	0.3601
C0	0.3456	0.3601	C1	0.3539	0.3669
	0.3463	0.3687		0.3552	0.3760
	0.3376	0.3616		0.3463	0.3687
	0.3381	0.3740		0.3470	0.3810
	0.3470	0.3810		0.3572	0.3891
C8	0.3463	0.3687	C9	0.3552	0.3760
	0.3376	0.3616	0.3616 0.3740	0.3463	0.3687
	0.3381	0.3740		0.3470	0.3810





Luminous Flux & Forward Voltage

Rank	LF [lm]	Condition
U1	91~100	
U2	100~109	350mA
U3	109~118.5	

Rank	V _F [V]	Condition	
Н	3.0~3.25	050 4	
I	3.25~3.50		
J	3.50~3.75	350mA	
К	3.75~4.0		





Labeling

Rank:

#1#2#3

QUANTITY: 1000

Lot No: #########

SSC PART NUMBER : SZW05A0A

SZW05A0A



Rank

#1#2#3

- #1: Luminous Flux: LF [lm]

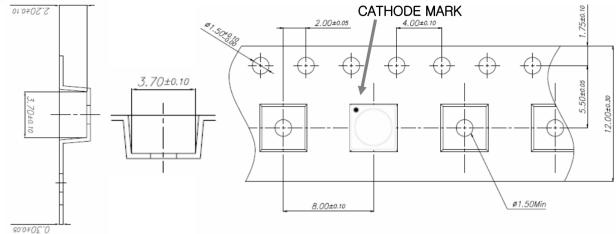
- #2: Color Coordinates: x, y

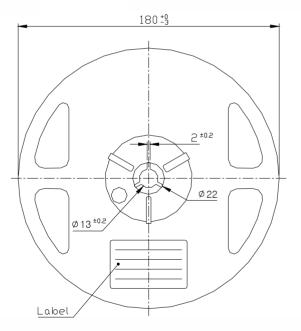
- #3 : Forward Voltage : V_F[V]

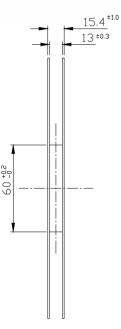




Emitter Carrier & Reel Packaging







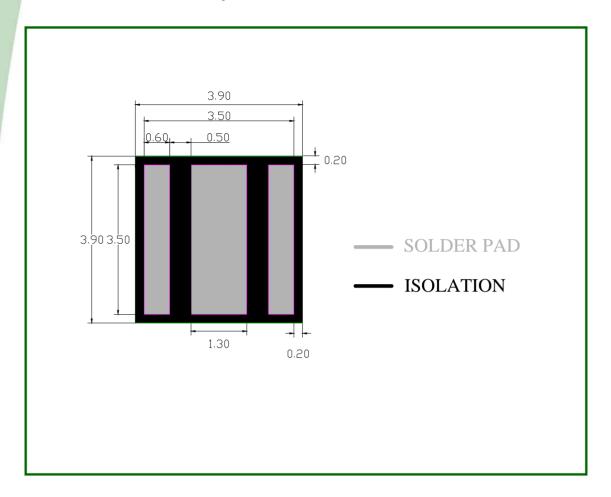
NOTFS:

- 10 sprocket hole pitch cumulative tolerance ±0.20
- 2. Camber not to exceed 1mm in 250mm
- 3. Material: Black conductive Polystyrene
- Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
- Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
- Pocket center and pocket hole center must be same position.





Recommended solder pad



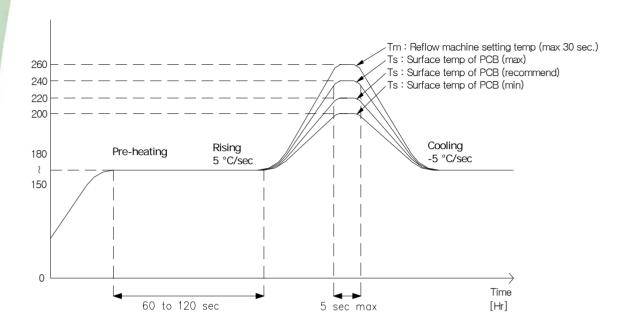
Notes:

[1] All dimensions are in millimeters.

[2] Scale: none

[3] This drawing without tolerances are for reference only

Reflow Soldering Conditions / Profile



* Caution

- 1. Reflow soldering should not be done more than one time.
- 2. Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- 3. Die slug is to be soldered.
- 4. When soldering, do not put stress on the LEDs during heating.
- 5. After soldering, do not warp the circuit board.
- 6. Recommend to use a convection type reflow machine with 7 ~ 8 zones.





Precaution for use

Storage

To avoid the moisture penetration, we recommend storing Z Power LEDs in a dry box with a desiccant . The recommended storage temperature range is 5C to 30C and a maximum humidity of 50%.

Use Precaution after Opening the Packaging
 Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Soldering should be done immediately after opening the package (within 24Hrs).
- b. Required conditions after opening the package
 - Sealing
 - Temperature : 5 ~ 40°C Humidity : less than 30%
- c. If the package has been opened more than 1 week or the color of the desiccant changes, components should be dried for 10-12hr at $60\pm5^{\circ}$ C
- Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- · Do not rapidly cool device after soldering.
- Components should not be mounted on warped (non coplanar) portion of PCB.
- Radioactive exposure is not considered for the products listed here in.
- Gallium arsenide is used in some of the products listed in this publication. These products are
 dangerous if they are burned or shredded in the process of disposal. It is also dangerous to
 drink the liquid or inhale the gas generated by such products when chemically disposed of.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc.

 When washing is required, IPA (Isopropyl Alcohol) should be used.
- When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- The appearance and specifications of the product may be modified for improvement without notice.
- Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- The slug is isolated from anode electrically.
 Therefore, we recommend that you don't isolate the heat sink.
- Attaching LEDs, do not use adhesives that outgas organic vapor.





Handling of Silicone resin LEDs

The Z-Power LED is encapsulated with a silicone resin for the highest flux efficiency. Notes for handling:

- Avoid touching silicone resin parts especially with sharp tools such as Pincette (Tweezers)
- Avoid leaving fingerprints on silicone resin parts.
- Silicone resin will attract dust so use covered containers for storage.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that excessive mechanical pressure on the surface of the resin must be prevented.
- It is not recommend to cover the silicone resin of the LEDs with other resin (epoxy, urethane, etc)